

Tantalum Surface Mount Capacitors – High Reliability
**T513 High Reliability Series (HRA),
Multiple Anode Low ESR MnO₂**

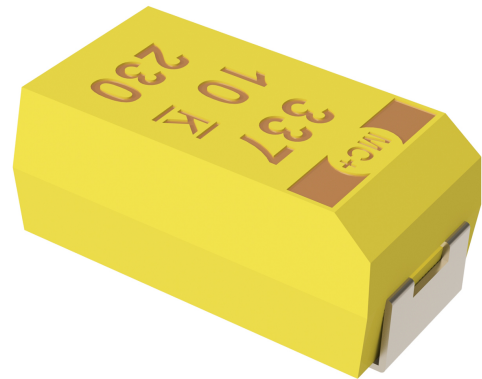
Overview

The KEMET T513 Surface Mount Capacitors are suitable for the High Reliability Series (HRA) requirements of industrial, telecom, defense, and aerospace markets. This surface mount series offers very low ESR and surge robustness designed for applications that require high

surge current and high ripple current capability. These benefits are achieved via a multiple anode construction similar to KEMET's T510 Series. The T513 HRA Series also offers various options including Weibull Grading, termination finish, and surge current.

Benefits

- Meets or exceeds EIA Standard 535BAAC
- Taped & Reel standard packaging per EIA 481
- High surge current capability
- Termination options B, C, H, K, and T
- High ripple current capability
- Surge testing options
- 100% steady-state accelerated aging
- ESR as low as 10 mΩ
- RoHS compliant 100% Sn terminations available



Applications

The T513 Series is suitable for the industrial, telecom, defense, and aerospace markets. Typical applications include decoupling and filtering in radar, sonar, power supply, guidance systems, and other high reliability applications.

Environmental Compliance

RoHS Compliant (6/6) according to Directive 2002/95/EC when ordered with 100% Sn solder or gold plated.

K-SIM

For a detailed analysis of specific part numbers, please visit ksim.kemet.com to access KEMET's K-SIM software. KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels.

Ordering Information

| T | 513 | X | 108 | K | 004 | B | H | 61 | 10 | |
|-----------------|---------------------|-------------|--|-----------------------|--|--|---|--|---|--|
| Capacitor Class | Series | Case Size | Capacitance Code (pF) | Capacitance Tolerance | Rated Voltage (VDC) | Failure Rate/Design | Termination Finish | Surge | ESR | Packaging (C-Spec) |
| T = Tantalum | Multiple anode COTS | D E X | First two digits represent significant figures. Third digit specifies number of zeros. | K = ±10% M = ±20% | 004 = 4 006 = 6.3 010 = 10 016 = 16 020 = 20 025 = 25 035 = 35 | A = N/A B = 0.1%/1,000 hours C = 0.01%/1,000 hours | C = Hot solder dipped H = Standard solder-coated (SnPb 5% Pb minimum) B = Gold-Plated K = Solder fused T = 100% Tin | 61 = None 62 = 10 cycles, 25°C after Weibull 63 = 10 cycles, -55°C and 85°C after Weibull 64 = 10 cycles, -55°C and 85°C before Weibull | 10 = Standard ESR 20 = Low ESR 30 = Ultra-low ESR | Blank = 7" Reel 7280 = 13" Reel 7610 = Bulk bag 7640 = Bulk plastic box WAFL = Waffle pack |

Performance Characteristics

| Item | Performance Characteristics |
|-------------------------|---|
| Operating Temperature | -55°C to 125°C |
| Rated Capacitance Range | 15 – 1,000 µF at 120 Hz/25°C |
| Capacitance Tolerance | K Tolerance (10%), M Tolerance (20%) |
| Rated Voltage Range | 4 – 35 VDC |
| DF (120 Hz) | Refer to Part Number Electrical Specification Table |
| ESR (100 kHz) | Refer to Part Number Electrical Specification Table |
| Leakage Current | ≤ 0.01 CV (µA) at rated voltage after 5 minutes |

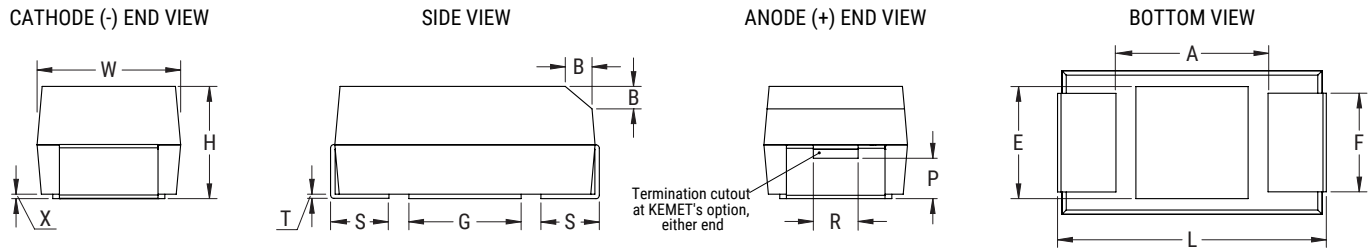
Qualification

| Test | Condition | Characteristics | | | | |
|--|--|-----------------|------------------------------|-------|----------|----------|
| Endurance | 85°C at rated voltage, 2,000 hours 125°C at 2/3 rated voltage, 2,000 hours | Δ C/C | Within ±10% of initial value | | | |
| | | DF | Within initial limits | | | |
| | | DCL | Within 1.25 x initial limit | | | |
| | | ESR | Within initial limits | | | |
| Storage Life | 125°C at 0 volts, 2,000 hours | Δ C/C | Within ±10% of initial value | | | |
| | | DF | Within initial limits | | | |
| | | DCL | Within 1.25 x initial limit | | | |
| | | ESR | Within initial limits | | | |
| Thermal Shock | MIL-STD-202, Method 107, Condition B, mounted, -55°C to 125°C, 1,000 cycles | Δ C/C | Within ±5% of initial value | | | |
| | | DF | Within initial limits | | | |
| | | DCL | Within 1.25 x initial limit | | | |
| | | ESR | Within initial limits | | | |
| Temperature Stability | Extreme temperature exposure at a succession of continuous steps at +25°C, -55°C, +25°C, +85°C, +125°C, +25°C | | +25°C | -55°C | +85°C | +125°C |
| | | Δ C/C | IL* | ±10% | ±10% | ±20% |
| | | DF | IL | IL | 1.5 x IL | 1.5 x IL |
| | | DCL | IL | n/a | 10 x IL | 12 x IL |
| Surge Voltage | 25°C and 85°C, 1.32 x rated voltage 1,000 cycles (125°C, 1.2 x rated voltage) | Δ C/C | Within ±5% of initial value | | | |
| | | DF | Within initial limits | | | |
| | | DCL | Within initial limits | | | |
| | | ESR | Within initial limits | | | |
| Mechanical Shock/ Vibration | MIL-STD-202, Method 213, Condition I, 100 G peak MIL-STD-202, Method 204, Condition D, 10 Hz to 2,000 Hz, 20 G peak | Δ C/C | Within ±10 of initial value | | | |
| | | DF | Within initial limits | | | |
| | | DCL | Within initial limits | | | |
| Additional Qualification Tests per MIL-PRF-55365/8 | Please contact KEMET for more information. | | | | | |

*IL = Initial limit

Dimensions – Millimeters (Inches)

Metric will govern



| Case Size | | Component | | | | | | | | | | | | | Typical Weight |
|-----------|---------|--------------------------|--------------------------|--------------------------|--------------------|--------------------|----------------------------|----------------------------|----------------|----------------|-----------------|----------------|----------------|----------------|----------------|
| KEMET | EIA | L | W | H | F ±0.1 ±(0.004) | S ±0.3 ±(0.012) | B ±0.15 (Ref) ±0.006 | X (Ref) | P (Ref) | R (Ref) | T (Ref) | A (Min) | G (Ref) | E (Ref) | (mg) |
| D | 7343-31 | 7.3±0.3 (0.287±0.012) | 4.3±0.3 (0.169±0.012) | 2.8±0.3 (0.110±0.012) | 2.4 (0.095) | 1.3 (0.051) | 0.5 (0.020) | 0.10±0.10 (0.004±0.004) | 0.9 (0.035) | 1.0 (0.039) | 0.13 (0.005) | 3.8 (0.150) | 3.5 (0.138) | 3.5 (0.138) | 349.43 |
| X | 7343-43 | 7.3±0.3 (0.287±0.012) | 4.3±0.3 (0.169±0.012) | 4.0±0.3 (0.157±0.012) | 2.4 (0.094) | 1.3 (0.051) | 0.5 (0.020) | 0.10±0.10 (0.004±0.004) | 1.7 (0.067) | 1.0 (0.039) | 0.13 (0.005) | 3.8 (0.150) | 3.5 (0.138) | 3.5 (0.138) | 430.15 |
| E | 7360-38 | 7.3±0.3 (0.287±0.012) | 6.0±0.3 (0.236±0.012) | 3.6±0.2 (0.142±0.008) | 4.1 (0.161) | 1.3 (0.051) | 0.5 (0.020) | 0.10±0.10 (0.004±0.004) | 0.9 (0.035) | 1.0 (0.039) | 0.13 (0.005) | 3.8 (0.150) | 3.5 (0.138) | 3.5 (0.138) | 500.73 |

Notes: (Ref) – Dimensions provided for reference only.

These weights are provided as reference. If exact weights are needed, please contact your KEMET Sales Representative.

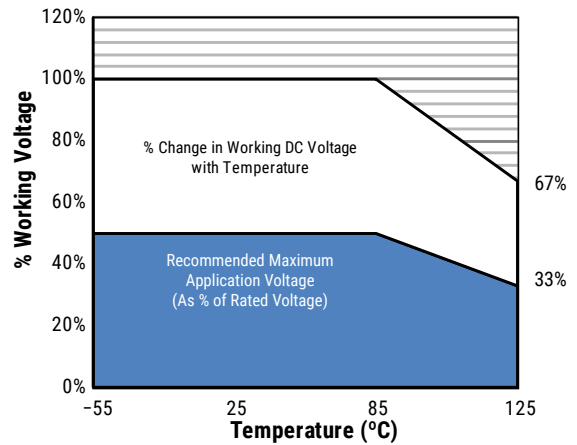
Table 1 – Ratings & Part Number Reference

| Rated Voltage | Rated Cap | Case Code/ Case Size | KEMET Part Number | DC Leakage | DF | Standard ESR | Low ESR | Ultra-low ESR | Maximum Operating Temp. |
|---------------|-----------|-------------------------|------------------------------|-------------------------|------------------------|--------------------------|--------------------------|--------------------------|-------------------------|
| VDC at 85°C | µF | KEMET/EIA | (See below for part options) | µA at +20°C Max./5 Min. | % at +20°C 120 Hz Max. | mΩ at +20°C 100 kHz Max. | mΩ at +20°C 100 kHz Max. | mΩ at +20°C 100 kHz Max. | °C |
| 4 | 680 | X/7343-43 | T513X687(1)004(2)(3)(4)(5) | 27.2 | 6.0 | 30 | N/A | N/A | 125 |
| 4 | 1000 | X/7343-43 | T513X108(1)004(2)(3)(4)(5) | 40.0 | 6.0 | 23 | 18 | N/A | 125 |
| 4 | 1000 | E/7360-38 | T513E108(1)004(6)(3)(4)(5) | 40.0 | 6.0 | 18 | 10 | N/A | 125 |
| 6.3 | 470 | X/7343-43 | T513X477(1)006(2)(3)(4)(5) | 29.6 | 6.0 | 30 | N/A | N/A | 125 |
| 6.3 | 680 | X/7343-43 | T513X687(1)006(2)(3)(4)(5) | 42.8 | 6.0 | 45 | 23 | N/A | 125 |
| 6.3 | 680 | E/7360-38 | T513E687(1)006(6)(3)(4)(5) | 42.8 | 6.0 | 23 | 12 | N/A | 125 |
| 10 | 330 | X/7343-43 | T513X337(1)010(6)(3)(4)(5) | 33.0 | 6.0 | 35 | N/A | N/A | 125 |
| 16 | 100 | D/7343-31 | T513D107(1)016(2)(3)(4)(5) | 16.0 | 6.0 | 75 | N/A | N/A | 125 |
| 16 | 150 | X/7343-43 | T513X157(1)016(2)(3)(4)(5) | 24.0 | 6.0 | 40 | 30 | N/A | 125 |
| 16 | 220 | X/7343-43 | T513X227(1)016(2)(3)(4)(5) | 35.2 | 10.0 | 40 | 25 | N/A | 125 |
| 20 | 100 | X/7343-43 | T513X107(1)020(6)(3)(4)(5) | 20.0 | 8.0 | 45 | 40 | 35 | 125 |
| 25 | 68 | X/7343-43 | T513X686(1)025(2)(3)(4)(5) | 17.0 | 8.0 | 45 | N/A | N/A | 125 |
| 25 | 100 | E/7360-38 | T513E107(1)025(2)(3)(4)(5) | 25.0 | 8.0 | 50 | N/A | N/A | 125 |
| 35 | 15 | D/7343-31 | T513D156(1)035(2)(3)(4)(5) | 5.3 | 6.0 | 100 | N/A | N/A | 125 |
| 35 | 33 | X/7343-43 | T513X336(1)035(2)(3)(4)(5) | 11.6 | 6.0 | 65 | 55 | N/A | 125 |
| 35 | 47 | X/7343-43 | T513X476(1)035(2)(3)(4)(5) | 16.5 | 8.0 | 65 | 55 | N/A | 125 |
| VDC at 85°C | µF | KEMET/EIA | (See below for part options) | µA at +20°C Max./5 Min. | % at +20°C 120 Hz Max. | mΩ at +20°C 100 kHz Max. | mΩ at +20°C 100 kHz Max. | mΩ at +20°C 100 kHz Max. | °C |
| Rated Voltage | Rated Cap | Case Code/ Case Size | KEMET Part Number | DC Leakage | DF | Standard ESR | Low ESR | Ultra-low ESR | Maximum Operating Temp. |

- (1) To complete KEMET part number, insert M for ±20%, K for ±10%. Designates Capacitance tolerance.
 - (2) To complete KEMET part number, insert B (0.1%/1,000 hours), or A = N/A. Designates Reliability Level.
 - (3) To complete KEMET part number, insert B = Gold-plated, C = Hot solder dipped, H = Solder-plated, K = Solder Fused or T = 100% Tin (Sn). Designates Termination Finish.
 - (4) To complete KEMET part number, insert 61 = None, 62 = 10 cycles +25°C, 63 = 10 cycles -55°C +85°C after Weibull or 64 = 10 cycles -55°C +85°C before Weibull. Designates Surge current option.
 - (5) To complete KEMET part number, insert 10 = Standard ESR, 20 = Low ESR or 30 = Ultra Low ESR. Designates ESR option.
 - (6) To complete KEMET part number, insert C (0.01%/1,000 hours), B (0.1%/1,000 hours), or A = N/A. Designates Reliability Level.
- Refer to Ordering Information for additional detail.

Recommended Voltage Derating Guidelines

| | -55°C to 85°C | 85°C to 125°C |
|---|-----------------------|-----------------------|
| % Change in Working DC Voltage with Temperature | V _R | 67% of V _R |
| Recommended Maximum Application Voltage | 50% of V _R | 33% of V _R |



Ripple Current/Ripple Voltage

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

1. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
2. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage. See the Reverse Voltage section for allowable limits.

The maximum power dissipation by case size can be determined using the table at right. The maximum power dissipation rating stated in the table must be reduced with increasing environmental operating temperatures. Refer to the table below for temperature compensation requirements.

| KEMET Case Code | EIA Case Code | Maximum Power Dissipation (P _{max}) mWatts at 25°C with +20°C Rise |
|-----------------|---------------|--|
| A | 3216-18 | 75 |
| B | 3528-21 | 85 |
| C | 6032-28 | 110 |
| D | 7343-31 | 150 |
| X | 7343-43 | 165 |
| E | 7360-38 | 200 |
| S | 3216-12 | 60 |
| T | 3528-12 | 70 |
| U | 6032-15 | 90 |
| V | 7343-20 | 125 |
| T510X | 7343-43 | 270 |
| T510E | 7360-38 | 285 |

| Temperature Compensation Multipliers for Maximum Ripple Current | | |
|---|----------|-----------|
| T ≤ 25°C | T ≤ 85°C | T ≤ 125°C |
| 1.00 | 0.90 | 0.40 |

T = Environmental Temperature

The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.

Using the P_{max} of the device, the maximum allowable rms ripple current or voltage may be determined.

$$I(max) = \sqrt{P_{max}/R}$$

$$E(max) = Z \sqrt{P_{max}/R}$$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

P_{max} = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Z = Impedance at specified frequency (ohms)

Reverse Voltage

Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe, plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the below table. The capacitors should not be operated continuously in reverse mode, even within these limits.

| Temperature | Permissible Transient Reverse Voltage |
|-------------|---------------------------------------|
| 25°C | 15% of Rated Voltage |
| 85°C | 5% of Rated Voltage |
| 125°C | 1% of Rated Voltage |

Table 2 – Land Dimensions/Courtyard

| KEMET | Metric Size Code | Density Level A: Maximum (Most) Land Protrusion (mm) | | | | | Density Level B: Median (Nominal) Land Protrusion (mm) | | | | | Density Level C: Minimum (Least) Land Protrusion (mm) | | | | | |
|----------------|------------------|--|------|------|------|-------|--|------|------|------|------|---|------|------|------|------|------|
| | | Case | EIA | W | L | S | V1 | V2 | W | L | S | V1 | V2 | W | L | S | V1 |
| D | 7343-31 | | 2.55 | 2.77 | 3.67 | 10.22 | 5.60 | 2.43 | 2.37 | 3.87 | 9.12 | 5.10 | 2.33 | 1.99 | 4.03 | 8.26 | 4.84 |
| E ¹ | 7360-38 | | 4.25 | 2.77 | 3.67 | 10.22 | 7.30 | 4.13 | 2.37 | 3.87 | 9.12 | 6.80 | 4.03 | 1.99 | 4.03 | 8.26 | 6.54 |
| X ¹ | 7343-43 | | 2.55 | 2.77 | 3.67 | 10.22 | 5.60 | 2.43 | 2.37 | 3.87 | 9.12 | 5.10 | 2.33 | 1.99 | 4.03 | 8.26 | 4.84 |

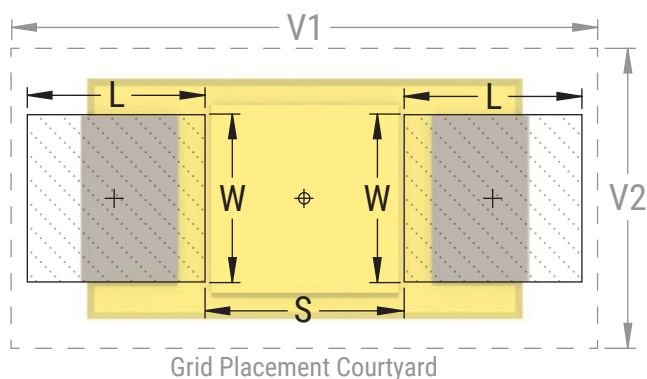
Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC-7351).

¹ Height of these chips may create problems in wave soldering.

² Land pattern geometry is too small for silkscreen outline.



Soldering Process

KEMET’s families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET’s recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

Please note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. “Wiping” the edges of a chip and heating the top surface is not recommended.

During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

| Profile Feature | SnPb Assembly | Pb-Free Assembly |
|---|---------------------|---------------------|
| Preheat/Soak | | |
| Temperature Minimum (T_{smin}) | 100°C | 150°C |
| Temperature Maximum (T_{smax}) | 150°C | 200°C |
| Time (t_s) from T_{smin} to T_{smax} | 60 – 120 seconds | 60 – 120 seconds |
| Ramp-up Rate (T_L to T_P) | 3°C/seconds maximum | 3°C/seconds maximum |
| Liquidous Temperature (T_L) | 183°C | 217°C |
| Time Above Liquidous (t_L) | 60 – 150 seconds | 60 – 150 seconds |
| Peak Temperature (T_P) | 220°C* 235°C** | 250°C* 260°C** |
| Time within 5°C of Maximum Peak Temperature (t_p) | 20 seconds maximum | 30 seconds maximum |
| Ramp-down Rate (T_P to T_L) | 6°C/seconds maximum | 6°C/seconds maximum |
| Time 25°C to Peak Temperature | 6 minutes maximum | 8 minutes maximum |

Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.

* For Case Size height > 2.5 mm

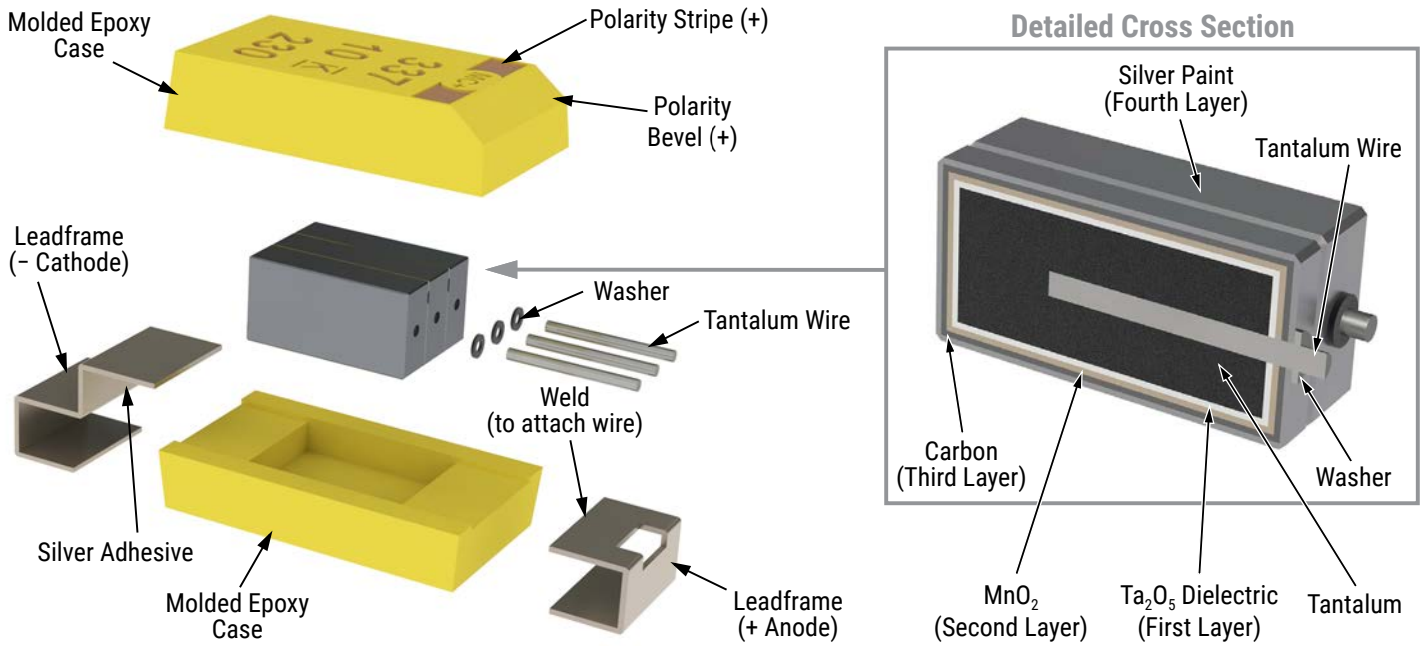
** For Case Size height ≤ 2.5 mm



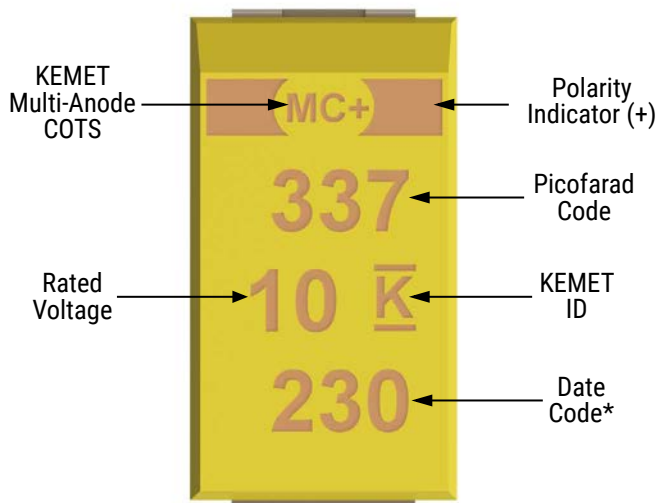
Storage

Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within three years of receipt.

Construction



Capacitor Marking



* 230 = 30th week of 2012

| Date Code * | |
|--|--|
| 1 st digit = Last number of Year | 2 = 2012 3 = 2013 4 = 2014 5 = 2015 6 = 2016 7 = 2017 |
| 2 nd and 3 rd digit = Week of the Year | 01 = 1 st week of the Year to 52 = 52 nd week of the Year |

Tape & Reel Packaging Information

KEMET’s molded chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with *EIA Standard 481: Embossed Carrier Taping of Surface Mount Components for Automatic Handling*. This packaging system is compatible with all tape-fed automatic pick-and-place systems.



Table 3 – Packaging Quantity

| Case Code | | Tape Width (mm) | 7" Reel* | 13" Reel* |
|-----------|---------|-----------------|----------|-----------|
| KEMET | EIA | | | |
| S | 3216-12 | 8 | 2,500 | 10,000 |
| T | 3528-12 | 8 | 3,000 | 10,000 |
| M | 3528-15 | 8 | 2,500 | 8,000 |
| U | 6032-15 | 12 | 1,000 | 5,000 |
| L | 6032-19 | 12 | 1,000 | 3,000 |
| W | 7343-15 | 12 | 1,000 | 3,000 |
| Z | 7343-17 | 12 | 1,000 | 3,000 |
| V | 7343-20 | 12 | 1,000 | 3,000 |
| A | 3216-18 | 8 | 2,000 | 9,000 |
| B | 3528-21 | 8 | 2,000 | 8,000 |
| C | 6032-28 | 12 | 500 | 3,000 |
| D | 7343-31 | 12 | 500 | 2,500 |
| Q | 7343-12 | 12 | 1,000 | 3,000 |
| Y | 7343-40 | 12 | 500 | 2,000 |
| X | 7343-43 | 12 | 500 | 2,000 |
| E/T428P | 7360-38 | 12 | 500 | 2,000 |
| H | 7360-20 | 12 | 1,000 | 2,500 |
| O | 7360-43 | 12 | 250 | 1,000 |

* No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.

Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



Table 4 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions – Millimeters (Inches) | | | | | | | | | |
|--|---------------------------------------|----------------------------------|------------------------------|-----------------------------|-----------------------------|-----------------------|----------------------------------|------------------|---------------------------|
| Tape Size | D ₀ | D ₁ Minimum Note 1 | E ₁ | P ₀ | P ₂ | R Reference Note 2 | S ₁ Minimum Note 3 | T Maximum | T ₁ Maximum |
| 8 mm | 1.5 +0.10/-0.0 (0.059 +0.004/-0.0) | 1.0 (0.039) | 1.75 ±0.10 (0.069 ±0.004) | 4.0 ±0.10 (0.157 ±0.004) | 2.0 ±0.05 (0.079 ±0.002) | 25.0 (0.984) | 0.600 (0.024) | 0.600 (0.024) | 0.100 (0.004) |
| 12 mm | | 1.5 (0.059) | | | | | | | |

| Variable Dimensions – Millimeters (Inches) | | | | | | | | | |
|--|---------------------------------------|----------------------------------|------------------------|-----------------------------|--|------------------------|-----------------|--|--|
| Tape Size | Pitch | B ₁ Maximum Note 4 | E ₂ Minimum | F | P ₁ | T ₂ Maximum | W Maximum | A ₀ , B ₀ & K ₀ | |
| 8 mm | Single (4 mm) | 4.35 (0.171) | 6.25 (0.246) | 3.5 ±0.05 (0.138 ±0.002) | 2.0 ±0.05 or 4.0 ±0.10 (0.079 ±0.002 or 0.157 ±0.004) | 2.5 (0.098) | 8.3 (0.327) | Note 5 | |
| 12 mm | Single (4 mm) and Double (8 mm) | 8.2 (0.323) | 10.25 (0.404) | 5.5 ±0.05 (0.217 ±0.002) | 2.0 ±0.05 (0.079 ±0.002) or 4.0 ±0.10 (0.157 ±0.004) or 8.0 ±0.10 (0.315 ±0.004) | 4.6 (0.181) | 12.3 (0.484) | | |

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
2. The tape, with or without components, shall pass around R without damage (see Figure 4).
3. If S₁ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481–D, paragraph 4.3, section b).
4. B₁ dimension is a reference dimension for tape feeder clearance only.
5. The cavity defined by A₀, B₀ and K₀ shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes (see Figure 2).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape (see Figure 3).
 - (e) see Addendum in EIA Standard 481–D for standards relating to more precise taping requirements.

Packaging Information Performance Notes

- 1. Cover tape break force:** 1.0 kg minimum.
- 2. Cover tape peel strength:** The total peel strength of the cover tape from the carrier tape shall be:

| Tape Width | Peel Strength |
|------------|----------------------------------|
| 8 mm | 0.1 to 1.0 newton (10 to 100 gf) |
| 12 mm | 0.1 to 1.3 newton (10 to 130 gf) |

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

- 3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA Standards 556 and 624.

Figure 2 – Maximum Component Rotation

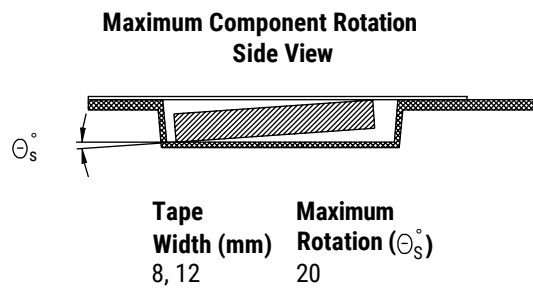


Figure 3 – Maximum Lateral Movement



Figure 4 – Bending Radius



Figure 5 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 5 – Reel Dimensions

Metric will govern

| Constant Dimensions – Millimeters (Inches) | | | | |
|--|------------------------------|---------------------------------------|--|---|
| Tape Size | A | B Minimum | C | D Minimum |
| 8 mm | 178 ±0.20 (7.008 ±0.008) | 1.5 (0.059) | 13.0 +0.5/-0.2 (0.521 +0.02/-0.008) | 20.2 (0.795) |
| 12 mm | 330 ±0.20 (13.000 ±0.008) | | | |
| Variable Dimensions – Millimeters (Inches) | | | | |
| Tape Size | N Minimum | W_1 | W_2 Maximum | W_3 |
| 8 mm | 50 (1.969) | 8.4 +1.5/-0.0 (0.331 +0.059/-0.0) | 14.4 (0.567) | Shall accommodate tape width without interference |
| 12 mm | | 12.4 +2.0/-0.0 (0.488 +0.078/-0.0) | 18.4 (0.724) | |

Figure 6 – Tape Leader & Trailer Dimensions

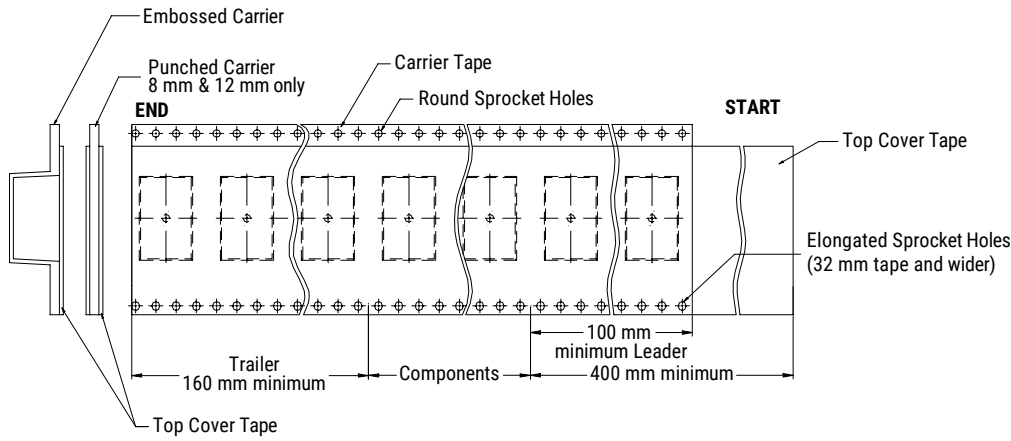


Figure 7 – Maximum Camber



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